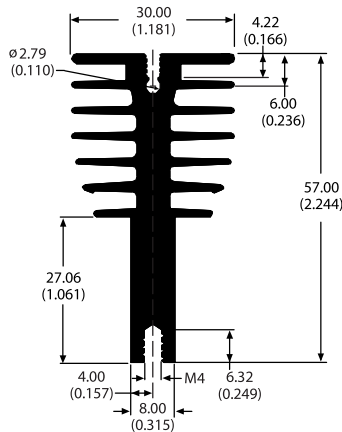


The Dual Mounting Surface style provides a flat component mounting surface on two sides of the profile. Some profiles allow back to back mounting of components on the circuit board permitting the sharing of a centrally mounted heat sink. Other profiles create a bridge configuration allowing components to be attached to each leg with a raised center section to clear adjacent components or create a tunnel for airflow. The clip used to retain the component interlocks between the first and second fin above the flat component mounting surface.

78205

kg/m: 1.57 • $\theta_n = 2.42$ °C/W • $\theta_f = 0.75$ °C/W

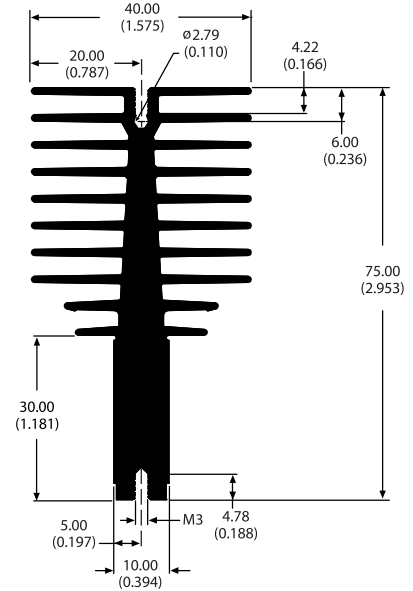
- One slot for vertical mounting to board



78070

kg/m: 2.57 • $\theta_n = 1.55$ °C/W • $\theta_f = 0.41$ °C/W

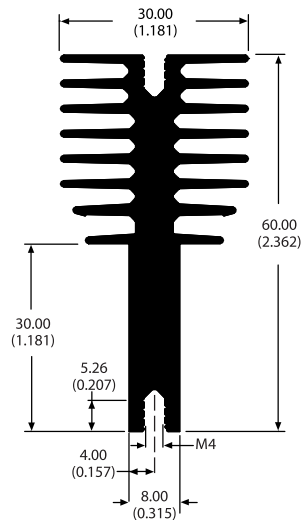
- One slot for vertical mounting to board



78220

kg/m: 1.66 • $\theta_n = 2.49$ °C/W • $\theta_f = 0.74$ °C/W

- One slot for vertical mounting to board



82955

kg/m: 1.41 • $\theta_n = 2.99$ °C/W • $\theta_f = 0.83$ °C/W

- One slot for vertical mounting to board

